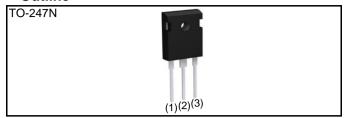


# SCT3080KL

## **N-channel SiC power MOSFET**

$V_{\rm DSS}$	1200V
R <sub>DS(on)</sub> (Typ.)	80mΩ
I <sub>D</sub> *1	31A
$P_D$	165W

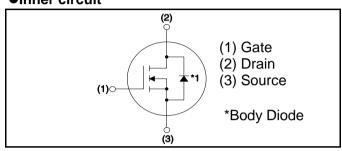
#### Outline



#### Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive
- 6) Pb-free lead plating; RoHS compliant

#### ●Inner circuit



### Application

- · Solar inverters
- DC/DC converters
- Switch mode power supplies
- · Induction heating
- Motor drives

### Packaging specifications

	Packing	Tube
	Reel size (mm)	-
Type	Tape width (mm)	-
Type	Basic ordering unit (pcs)	30
	Taping code	C11
	Marking	SCT3080KL

## ● Absolute maximum ratings (T<sub>vj</sub> = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit
Drain - Source Voltage		$V_{DSS}$	1200	V
Continuous Drain current	T <sub>c</sub> = 25°C	I <sub>D</sub> *1	31	Α
Continuous Drain current	T <sub>c</sub> = 100°C	I <sub>D</sub> *1	22	Α
Pulsed Drain current (T <sub>c</sub> = 25°C)		I <sub>D,pulse</sub> <sup>*2</sup> 77		Α
Gate - Source voltage (DC)		$V_{GSS}$	-4 to +22	V
Gate - Source surge voltage (t <sub>surge</sub> < 300nsec)		V <sub>GSS_surge</sub> *3	-4 to +26	V
Recommended drive voltage		$V_{GS\_op}^{*4}$	0 / +18	V
Virtual Junction temperature		$T_{vj}$	175	°C
Range of storage temperature		T <sub>stg</sub>	-55 to +175	°C

# ullet Electrical characteristics (T<sub>vj</sub> = 25°C unless otherwise specified)

Doromotor	Symbol	Conditions	Values			Unit
Parameter	Symbol		Min.	Тур.	Max.	Offic
		$V_{GS} = 0V$ , $I_D = 1mA$				
Drain - Source breakdown voltage	$V_{(BR)DSS}$	$T_{vj} = 25^{\circ}C$	1200	-	-	V
renage		T <sub>vj</sub> = -55°C	1200	-	-	
		$V_{GS} = 0V, V_{DS} = 1200V$				
Zero Gate voltage Drain current	I <sub>DSS</sub>	$T_{vj} = 25^{\circ}C$	-	1	10	μΑ
Drain Garrein		$T_{vj} = 150$ °C	-	2	-	
Gate - Source leakage current	I <sub>GSS+</sub>	$V_{GS} = +22V , V_{DS} = 0V$	-	-	100	nA
Gate - Source leakage current	I <sub>GSS-</sub>	$V_{GS} = -4V$ , $V_{DS} = 0V$	-	-	-100	nA
Gate threshold voltage	V <sub>GS (th)</sub>	$V_{DS} = 10V, I_D = 5mA$	2.7		5.6	V
		$V_{GS} = 18V, I_D = 10A$				
Static Drain - Source on - state resistance	R <sub>DS(on)</sub> *5	$T_{vj} = 25^{\circ}C$	-	80	104	mΩ
on state resistance		T <sub>vj</sub> = 150°C	-	136	-	
Gate input resistance	$R_{G}$	f = 1MHz, open drain	-	12	-	Ω

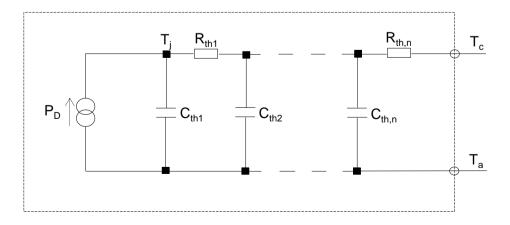
#### ●Thermal resistance

Parameter	Symbol	Values			Unit
raianietei		Min.	Тур.	Max.	Offic
Thermal resistance, junction - case	$R_{thJC}$	-	0.70	0.91	K/W

●Typical Transient Thermal Characteristics

Symbol	Value	Unit
R <sub>th1</sub>	9.00E-02	
R <sub>th2</sub>	5.96E-01	K/W
R <sub>th3</sub>	1.47E-02	

Symbol	Value	Unit
C <sub>th1</sub>	1.23E-03	
$C_{th2}$	7.32E-03	Ws/K
$C_{th3}$	1.64E-01	Ī



# ullet Electrical characteristics ( $T_{vj} = 25^{\circ}C$ unless otherwise specified)

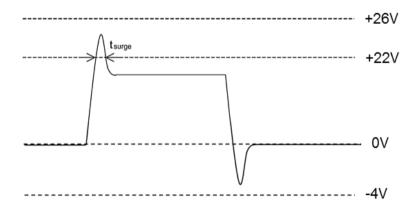
Dorometer	Symbol	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Transconductance	<b>g</b> fs *5	$V_{DS} = 10V, I_{D} = 10A$	-	4.4	-	S
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0V$	-	785	-	
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 800V	-	75	-	pF
Reverse transfer capacitance	C <sub>rss</sub>	f = 1MHz	-	35	-	
Effective output capacitance, energy related	C <sub>o(er)</sub>	$V_{GS} = 0V$ $V_{DS} = 0V \text{ to } 600V$	-	74	-	pF
Total Gate charge	Qg *5	$V_{DS} = 600V$ $I_{D} = 10A$	-	60	•	
Gate - Source charge	Q <sub>gs</sub> *5	$V_{GS} = 18V$	ı	11	-	nC
Gate - Drain charge	Q <sub>gd</sub> *5	See Fig. 1-1.	-	31	-	
Turn - on delay time	t <sub>d(on)</sub> *5	V <sub>DS</sub> = 400V	-	15	-	
Rise time	t <sub>r</sub> *5	$I_D = 10A$ $V_{GS} = 0V/+18V$	-	22	-	
Turn - off delay time	t <sub>d(off)</sub> *5	$R_G = 0\Omega$ $R_L = 40\Omega$	-	29	-	ns
Fall time	t <sub>f</sub> *5	See Fig. 1-1, 1-2.	-	24	-	
Turn - on switching loss	E <sub>on</sub> *5	$V_{DS} = 600V$ $V_{GS} = 0V/18V$ , $I_{D} = 10A$ $R_{G} = 0\Omega$ , $L = 750\mu H$	-	132	-	1
Turn - off switching loss	E <sub>off</sub> *5	$E_{on}$ includes diode reverse recovery $L_{\sigma}$ = 50nH, $C_{\sigma}$ = 200pF See Fig. 2-1, 2-2.	-	18	-	μJ

## ullet Body diode electrical characteristics (Source-Drain) ( $T_{vj} = 25^{\circ}$ C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
raiailletei	Symbol	Conditions	Min.	Тур.	Max.	Offic
Body diode continuous, forward current	I <sub>S</sub> *1	T <sub>c</sub> = 25°C	ı	ı	31	А
Body diode direct current, pulsed	I <sub>SM</sub> *2	1 <sub>c</sub> = 23 0	1	ı	77	Α
Forward voltage	V <sub>SD</sub> *5	$V_{GS} = 0V, I_{S} = 10A$	•	3.2		V
Reverse recovery time	t <sub>rr</sub> *5	$I_F = 10A$ $V_R = 600V$	ı	17	ı	ns
Reverse recovery charge	Q <sub>rr</sub> *5	di/dt = 1100A/µs	-	50	-	nC
Peak reverse recovery current	I <sub>rrm</sub> *5	$L_{\sigma} = 50$ nH, $C_{\sigma} = 200$ pF See Fig. 3-1, 3-2.	-	6	-	А

<sup>\*1</sup> Limited by maximum  $T_{vi}$  and for Max.  $R_{thJC}$ .

## \*3 Example of acceptable $V_{\text{GS}}$ waveform



\*5 Pulsed

<sup>\*2</sup> PW  $\leq$  10 $\mu$ s, Duty cycle  $\leq$  1%

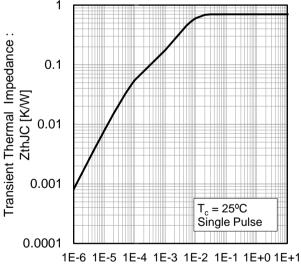
 $<sup>^{*}4</sup>$  Please be advised not to use SiC-MOSFETs with  $V_{GS}$  below 13V as doing so may cause thermal runaway.

Fig.1 Power Dissipation Derating Curve 180 160 Power Dissipation: P<sub>D</sub> [W] 140 120 100 80 60 40 20 0 75 25 125 175 Case Temperature : T<sub>C</sub> [°C]

Operation in this area is limited by  $R_{DS(on)}$ Drain Current: I<sub>D</sub> [A] 10 PW = 10µs\* PW = 100µs PW = 1ms 1 PW = 10ms  $T_c = 25^{\circ}C$ Single Pulse \*Calculation(PW≤10µs) 0.1 0.1 10 100 1000 10000 Drain - Source Voltage : V<sub>DS</sub> [V]

Fig.2 Maximum Safe Operating Area

Fig.3 Typical Transient Thermal Resistance vs. Pulse Width



Pulse Width: PW [s]

Fig.4 Typical Output Characteristics(I)

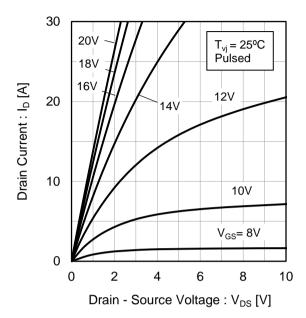


Fig.5 Typical Output Characteristics(II)

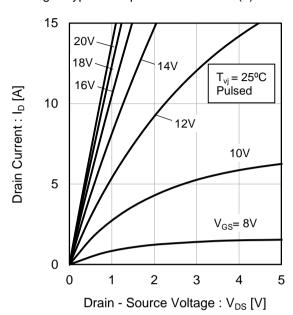
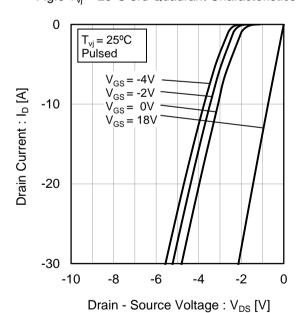
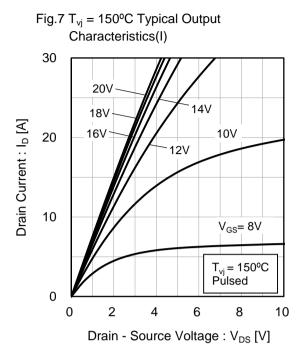


Fig.6  $T_{v_i}$  = 25°C 3rd Quadrant Characteristics





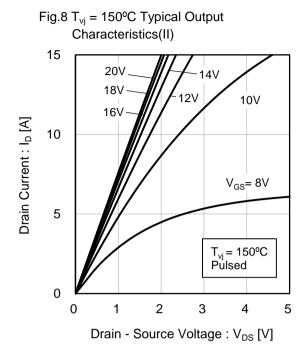


Fig.9  $T_{vj} = 150^{\circ}C$  3rd Quadrant Characteristics T<sub>vi</sub> = 150°C Pulsed  $V_{GS} = -4V$  $V_{GS} = -2V$ Drain Current : I<sub>D</sub> [A] -10  $V_{GS} = 0V$  $V_{GS}^{GS} = 18V$ -20 -30 -10 -8 -6 -2 0 Drain - Source Voltage : V<sub>DS</sub> [V]

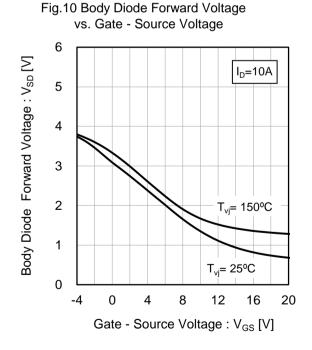


Fig.11 Typical Transfer Characteristics (I)

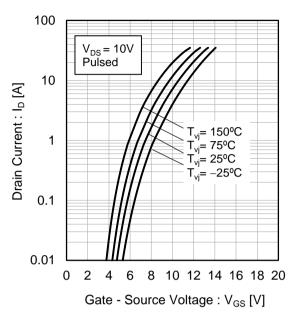


Fig.12 Typical Transfer Characteristics (II)

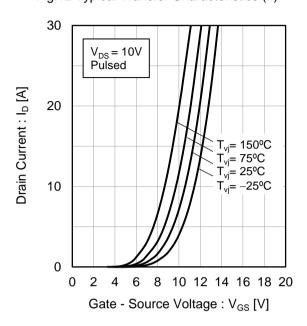


Fig.13 Gate Threshold Voltage vs. Junction Temperature

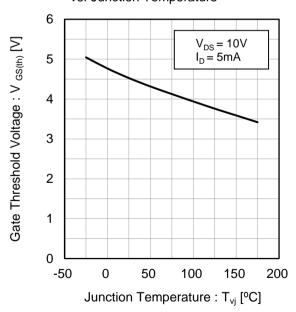
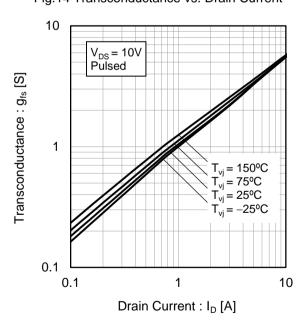
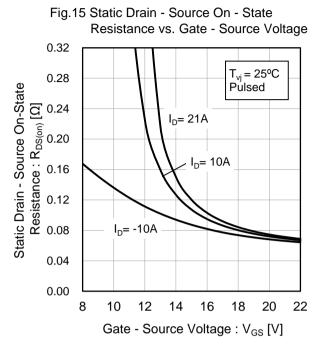


Fig.14 Transconductance vs. Drain Current





Resistance vs. Junction Temperature 0.18  $V_{GS} = 18V$ Pulsed Static Drain - Source On-State Resistance :  $R_{DS(on)} [\Omega]$ 0.15 I<sub>D</sub>= 21A I<sub>D</sub>=10A 0.12 -10A 0.09 0.06 0.03 0.00 -50 0 50 100 200 150 Junction Temperature : T<sub>vi</sub> [°C]

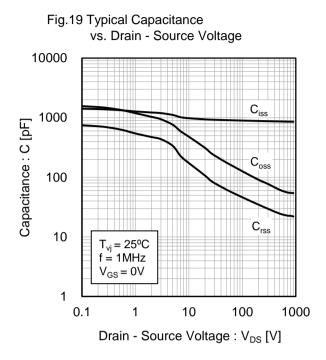
Fig.16 Static Drain - Source On - State

Fig.17 Static Drain - Source On - State Resistance vs. Drain Current 1 Static Drain - Source On-State Resistance:  $R_{DS(on)}[\Omega]$ 0.1  $T_{vj} = 150^{\circ}C$  $T_{vj} = 125^{\circ}C$  $T_{vi}^{''} = 75^{\circ}C$  $T_{vj} = 25^{\circ}C$  $V_{GS} = 18V$  $T_{vi} = -25^{\circ}C$ Pulsed 0.01 10 100 Drain Current: I<sub>D</sub> [A]

Voltage vs. Junction Temperature 1.04 1.03 Normalized Drain - Source Breakdown Voltage 1.02 1.01 1.00 0.99 0.98 -50 50 100 150 200 Junction Temperature : T<sub>vj</sub> [°C]

ROHM

Fig.18 Normalized Drain - Source Breakdown



25

T<sub>vj</sub> = 25°C

20

Soo J

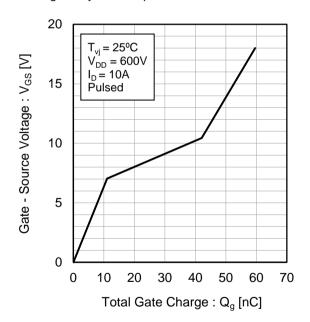
10

0 100 200 300 400 500 600 700 800

Drain - Source Voltage : V<sub>DS</sub> [V]

Fig.20 C<sub>oss</sub> Stored Energy

Fig.21 Dynamic Input Characteristics



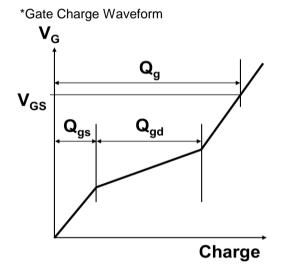


Fig.19 Typical Switching Time vs. Drain Current

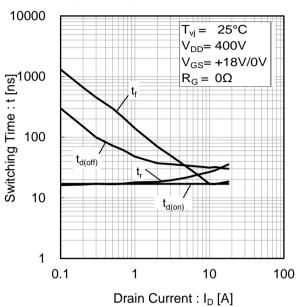


Fig.20 Typical Switching Loss vs. Drain - Source Voltage

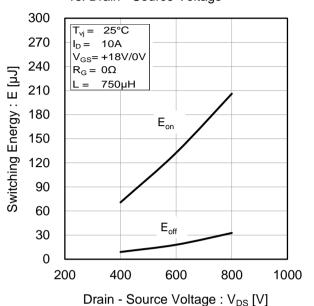


Fig.21 Typical Switching Loss vs. Drain Current

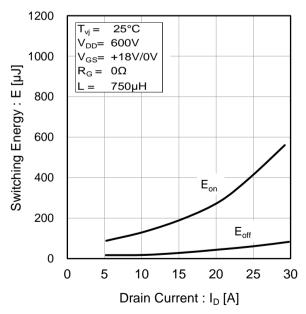
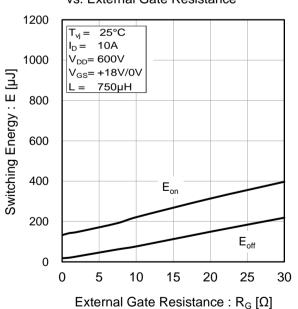


Fig.22 Typical Switching Loss vs. External Gate Resistance



#### Measurement circuits and waveforms

Fig.1-1 Gate Charge and Switching Time Measurement Circuit

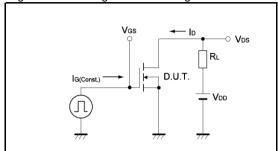


Fig.2-1 Switching Energy Measurement Circuit

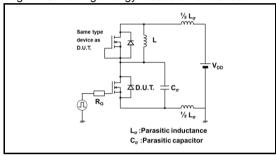


Fig.3-1 Reverse Recovery Time Measurement Circuit

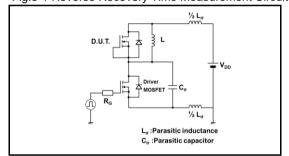


Fig.1-2 Waveforms for Switching Time

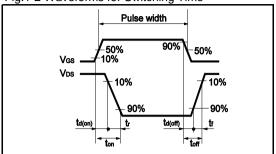


Fig.2-2 Waveforms for Switching Energy Loss

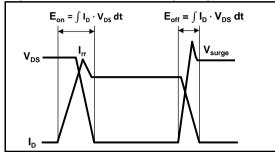
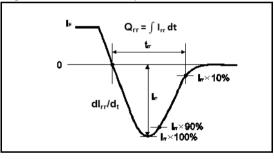
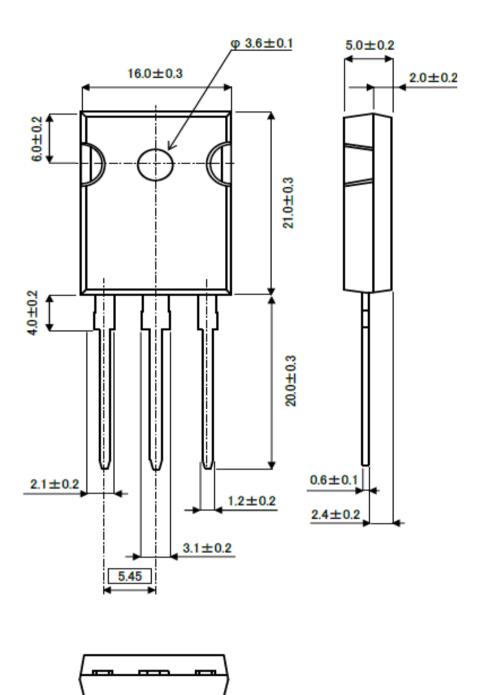


Fig.3-2 Reverse Recovery Waveform

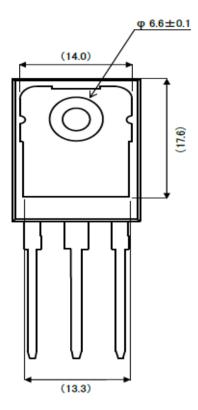


### ●Package Dimensions



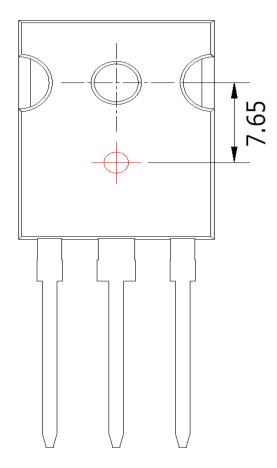


Datasheet



Unit: mm

## **●**Die Bonding Layout





Datasheet

- •Front view of the packaging.
- •Dimensions are design values.
- ·If the heat sink is to be installed, it should be in contact with the die bonding point.

Unit: mm

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